

88D D ■ 8235605 0014942 4 ■ SIEG

88D 14942 D T-39-13

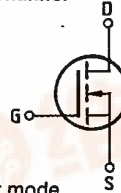
BUZ 221

SIEMENS AKTIENGESELLSCHAFT

Main ratings

Drain-source voltage $V_{DS} = 800\text{ V}$
 Continuous drain current $I_D = 5,5\text{ A}$
 Drain-source on-resistance $R_{DS(on)} = 2\ \Omega$

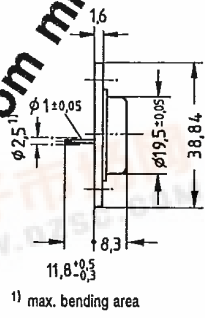
N-Channel



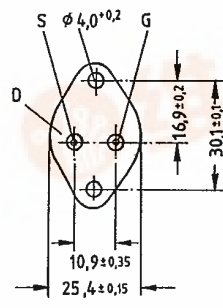
Description FREDET with fast-recovery reverse diode, N-channel, enhancement mode
Case Metal case 3A2 in accordance with DIN 41 872, or TO 204 AA (TO 3) in accordance with JEDEC. Approx. weight 12 g

Type	Ordering code
BUZ 221	C67078-A1104-A2

Available from mid 1987



1) max. bending area



Dimensions in mm

Maximum ratings

Description	Symbols	Rated	Units	Conditions
Drain-source voltage	V_{DS}	800	V	
Drain-gate voltage	V_{DGR}	800	V	$R_{GS} = 20\text{ k}\Omega$
Continuous drain current	I_D	5,5	A	$T_C = 35\text{ }^\circ\text{C}$
Pulsed drain current	I_{Dpuls}	22	A	$T_C = 25\text{ }^\circ\text{C}$
Gate-source voltage	V_{GS}	±20	V	
Max. power dissipation	P_D	125	W	$T_C = 25\text{ }^\circ\text{C}$
Operating and storage temperature range	T_j	-55... +150	°C	
DIN humidity category	C			DIN 40 040
IEC climatic category		55/150/56		DIN IEC 68-1

Thermal resistance

Chip - case	$R_{th\text{JC}}$	≤1,0	K/W
Chip - ambient	$R_{th\text{JA}}$	≤35	K/W

652

1234

D-11



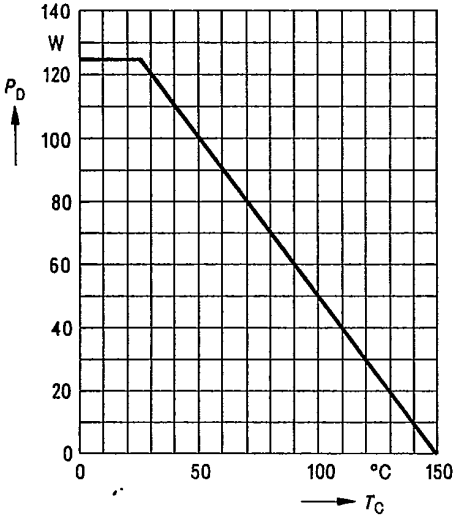
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Electrical characteristics(at $T_j = 25^\circ\text{C}$ unless otherwise specified)

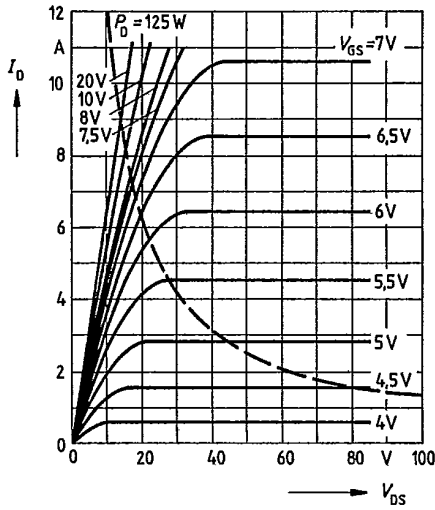
Description	Symbol	Characteristics			Unit	Conditions	
		min.	typ.	max.			
Static ratings							
Drain-source breakdown voltage	$V_{(BR)DSS}$	800	—	—	V	$V_{GS} = 0V$ $I_D = 0,25mA$	
Gate threshold voltage	$V_{GS(th)}$	2,1	3,0	4,0		$V_{DS} = V_{GS}$ $I_D = 1mA$	
Zero gate voltage drain current	I_{DSS}	—	20	250	μA	$T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$ $V_{DS} = 800V$ $V_{GS} = 0V$	
Gate-source leakage current	I_{GSS}	—	10	100	nA	$V_{GS} = 20V$ $V_{DS} = 0V$	
Drain-source on-resistance	$R_{DS(on)}$	—	1,8	2,0	Ω	$V_{GS} = 10V$ $I_D = 4,2A$	
Dynamic ratings							
Forward transconductance	g_{fs}	1,8	3,4	—	S	$V_{GS} = 25V$ $I_D = 4,2A$	
Input capacitance	C_{iss}	—	3,9	5,0	nF	$V_{GS} = 0V$	
Output capacitance	C_{oss}	—	200	350	pF	$V_{DS} = 25V$ $f = 1MHz$	
Reverse transfer capacitance	C_{rss}	—	80	140			
Turn-on time t_{on} ($t_{on} = t_d(on) + t_r$)	$t_d(on)$	—	60	90	ns	$V_{CC} = 30V$ $I_D = 2,5A$ $V_{GS} = 10V$ $R_{GS} = 50\Omega$	
	t_r	—	90	140			
Turn-off time t_{off} ($t_{off} = t_d(off) + t_f$)	$t_d(off)$	—	330	430			
	t_f	—	110	140			
Fast-recovery reverse diode							
Continuous reverse drain current	I_{DR}	—	—	5,5	A	$T_C = 25^\circ\text{C}$	
Pulsed reverse drain current	I_{DRM}	—	—	22			
Diode forward on-voltage	V_{SD}	—	1,1	1,55	V	$I_F = 2 \times I_{DR}$ $V_{GS} = 0V, T_j = 25^\circ\text{C}$	
Reverse recovery time	t_{rr}	—	180	250	ns	$T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	$I_F = I_{DR}$ $di/dt = 100A/\mu s$ $V_R = 100V$
		—	220	300			
Reverse recovery charge	Q_{rr}	—	0,65	1,2	μC	$T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	
		—	2,6	5,0			
Repetitive peak reverse current	I_{RRM}	—	—	—	A	$T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	
		—	15	—			

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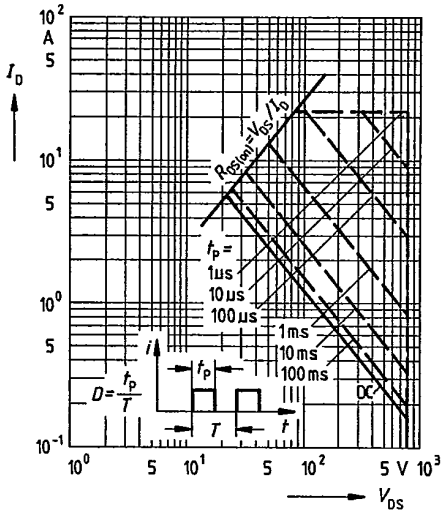
Power dissipation $P_D = f(T_C)$



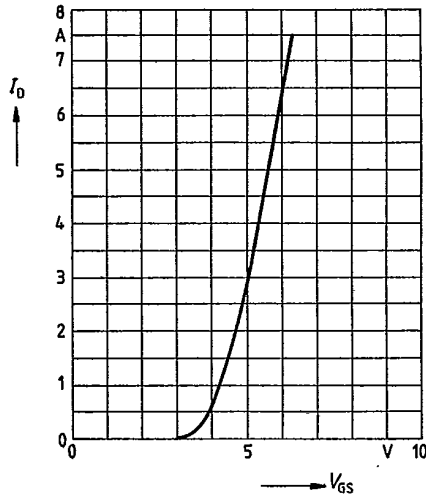
Typical output characteristics $I_D = f(V_{DS})$
parameter: 80 μ s pulse test,
 $T_j = 25^\circ\text{C}$



Safe operating area $I_D = f(V_{DS})$
parameter: $D = 0.01$, $T_C = 25^\circ\text{C}$



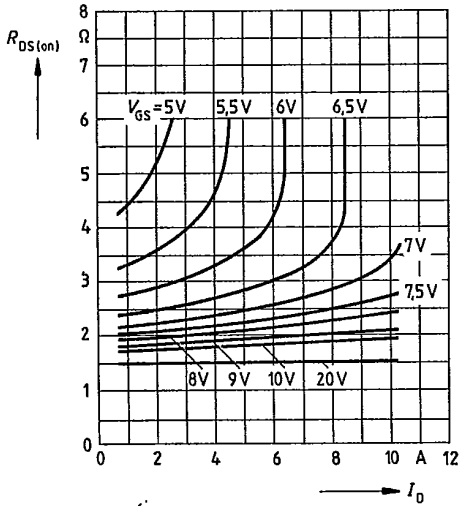
Typical transfer characteristic $I_D = f(V_{GS})$
parameter: 80 μ s pulse test,
 $V_{DS} = 25\text{V}$, $T_j = 25^\circ\text{C}$



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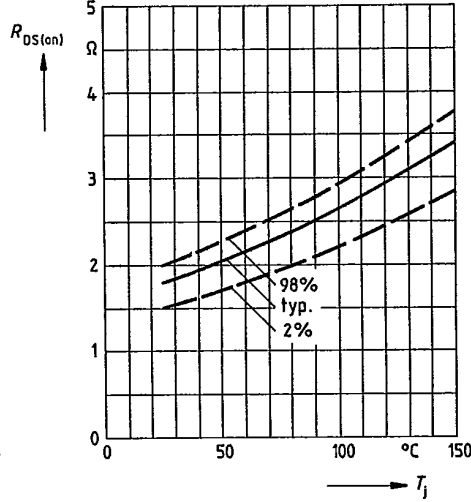
Typical drain-source on-state resistance

$R_{DS(on)} = f(I_D)$
parameter: $V_{GS} = 10V, T_j = 25^\circ C$



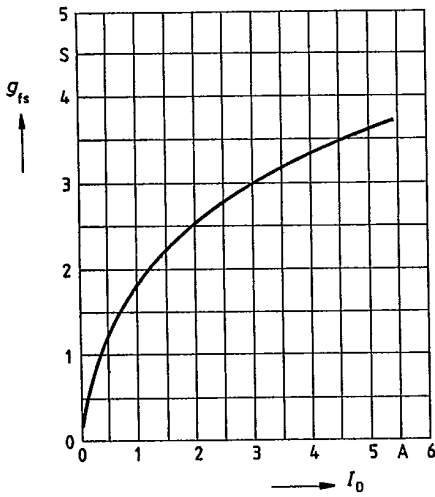
Drain-source on-state resistance

$R_{DS(on)} = f(T_j)$
parameter: $I_D = 4.2A, V_{GS} = 10V$
(spread)



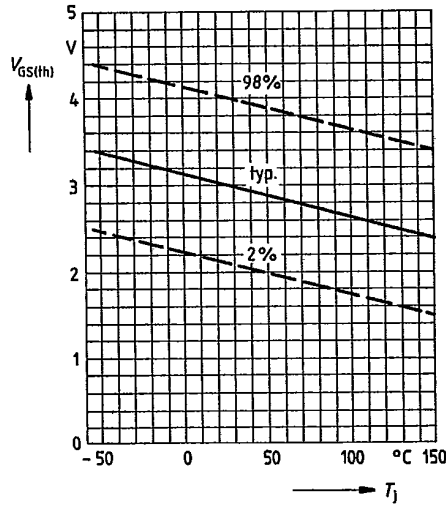
Typical transconductance $g_{fs} = f(I_D)$

parameter: 80 μs pulse test,
 $V_{DS} = 25V, T_j = 25^\circ C$



Gate threshold voltage $V_{GS(th)} = f(T_j)$

parameter: $V_{DS} = V_{GS}, I_D = 1mA$
(spread)



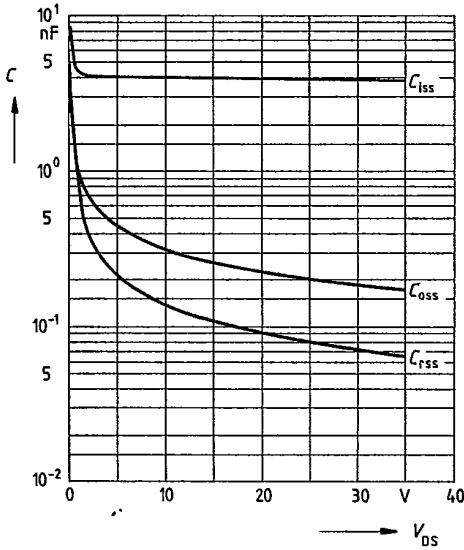
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88D 14946 D T-39-13

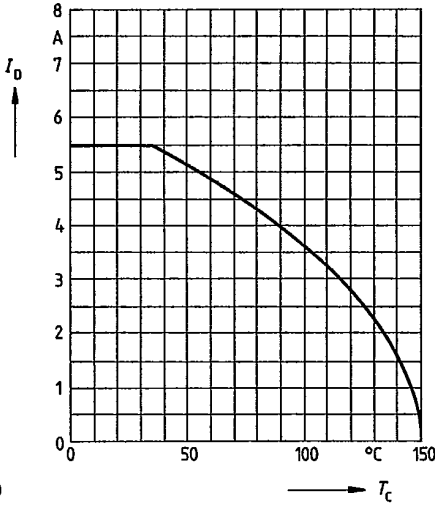
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Typical capacitances $C = f(V_{DS})$
parameter: $V_{GS} = 0, f = 1\text{MHz}$

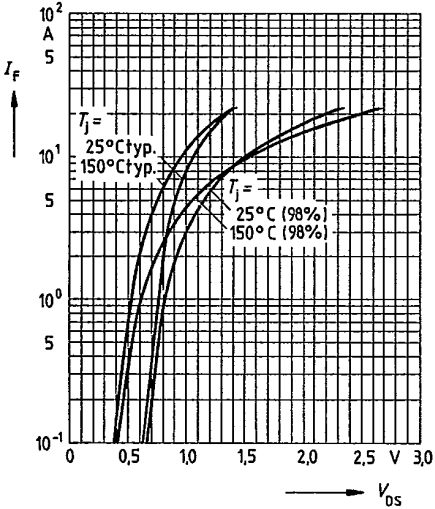


Continuous drain current $I_D = f(T_C)$
parameter: $V_{GS} \geq 10\text{V}$



Forward characteristic of reverse diode

$I_F = f(V_{SD})$
parameter: $T_j, t_p = 80 \mu\text{s}$
(spread)



656

1238

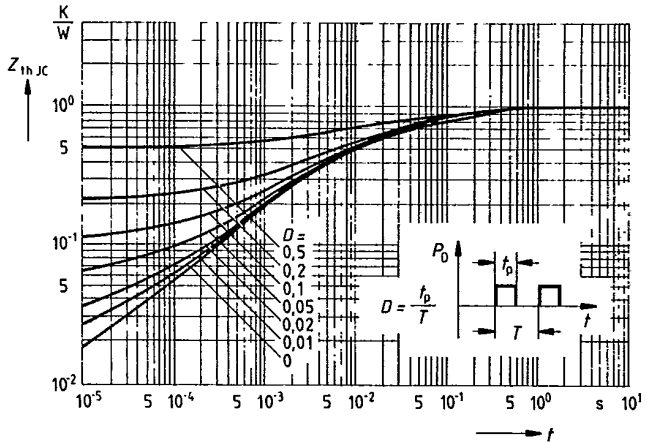
E-01

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Transient thermal impedance $Z_{thJC} = f(t)$
parameter: $D = t_p/T$



Typical gate-charge $V_{GS} = f(Q_{Gate})$
parameter: $I_{D\ pulse} = 9A$

